



November 2014

# FFPF08S60S

## 8 A, 600 V, STEALTH™ II Diode

### Features

- Stealth Recovery  $t_{rr} = 30 \text{ ns}$  (@  $I_F = 8 \text{ A}$ )
- Max Forward Voltage,  $V_F = 3.4 \text{ V}$  (@  $T_C = 25^\circ\text{C}$ )
- 600 V Reverse Voltage and High Reliability
- RoHS Compliant

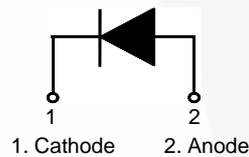
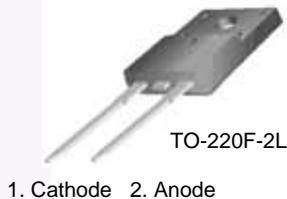
### Applications

- General Purpose
- SMPS
- Boost Diode in Continuous Mode Power Factor Corrections
- Power Switching Circuits

### Description

The FFPF08S60S is STEALTH™ II diode with soft recovery characteristics. It is silicon nitride passivated ion-implanted epitaxial planar construction. This device is intended for use as freewheeling of boost diode in switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

### Pin Assignments



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Unit
$V_{RRM}$	Peak Repetitive Reverse Voltage	600	V
$V_{RWM}$	Working Peak Reverse Voltage	600	V
$V_R$	DC Blocking Voltage	600	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 95^\circ\text{C}$	8	A
$I_{FSM}$	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	80	A
$T_J, T_{STG}$	Operating Junction and Storage Temperature	- 65 to +175	$^\circ\text{C}$

### Thermal Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.4	$^\circ\text{C}/\text{W}$

### Package Marking and Ordering Information

Part Number	Top Mark	Package	Reel Size	Tape Width	Quantity
FFPF08S60S	F08S60S	TO-220F-2L	-	-	50

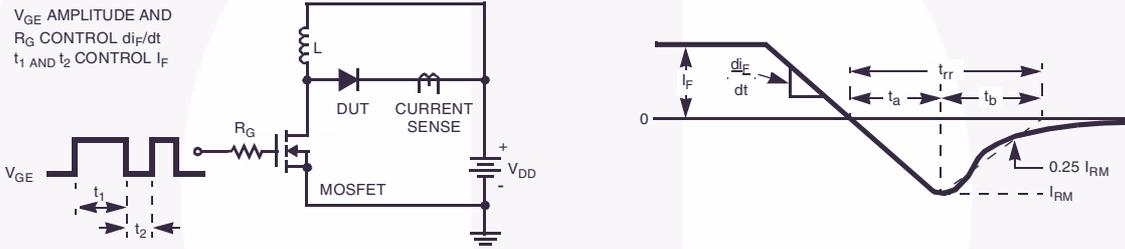
**Electrical Characteristics**  $T_C = 25^\circ\text{C}$  unless otherwise noted

Parameter	Conditions	Min.	Typ.	Max	Unit
$V_F^1$	$I_F = 8\text{ A}$	-	2.1	2.6	V
	$I_F = 8\text{ A}$	-	1.6	-	V
$I_R^1$	$V_R = 600\text{ V}$	-	-	100	$\mu\text{A}$
	$V_R = 600\text{ V}$	-	-	500	$\mu\text{A}$
$t_{rr}$	$I_F = 1\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	-	25	ns
$t_{rr}$	$I_F = 8\text{ A}$ , $di_F/dt = 200\text{ A}/\mu\text{s}$ , $V_R = 390\text{ V}$	-	19	30	ns
$I_{rr}$		-	2.2	-	A
S factor		-	0.6	-	-
$Q_{rr}$		-	21	-	nC
$t_{rr}$	$I_F = 8\text{ A}$ , $di_F/dt = 200\text{ A}/\mu\text{s}$ , $V_R = 390\text{ V}$	-	58	-	ns
$I_{rr}$		-	4.3	-	A
S factor		-	1.3	-	-
$Q_{rr}$		-	125	-	nC
$W_{AVL}$	Avalanche Energy ( $L = 40\text{ mH}$ )	20	-	-	mJ

**Notes:**

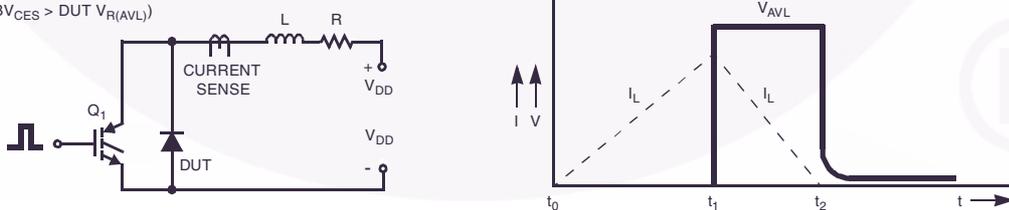
1. Pulse : Test Pulse width = 300  $\mu\text{s}$ , Duty Cycle = 2%

**Test Circuit and Waveforms**



**Figure 1. Diode Reverse Recovery Test Circuit & Waveform**

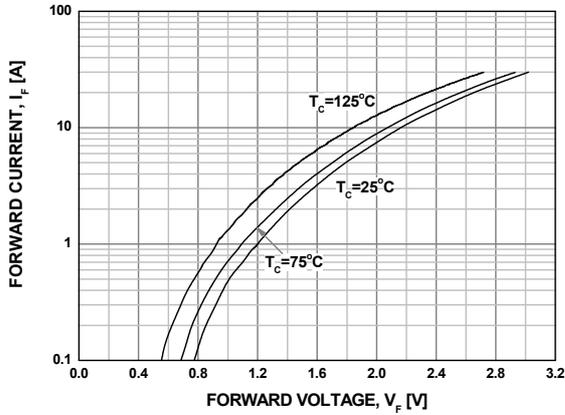
- $I = 0.5\text{ A}$
- $L = 80\text{ mH}$
- $R < 0.1\ \Omega$
- $V_{DD} = 200\text{ V}$
- $E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$
- $Q_1 = \text{IGBT } (BV_{CES} > \text{DUT } V_{R(AVL)})$



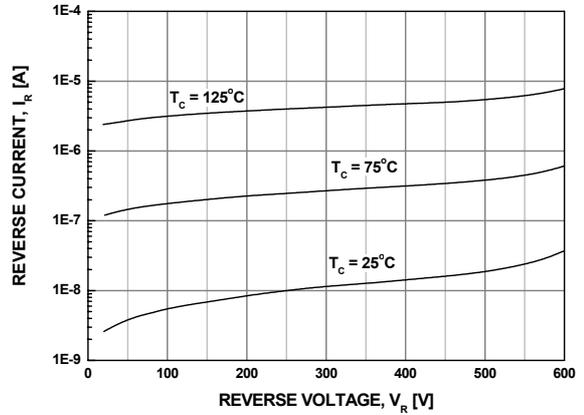
**Figure 2. Unclamped Inductive Switching Test Circuit & Waveform**

**Typical Performance Characteristics**  $T_c = 25^\circ\text{C}$  unless otherwise noted

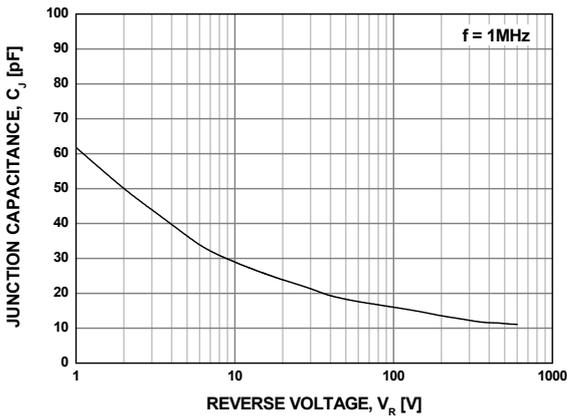
**Figure 3. Typical Forward Voltage Drop**



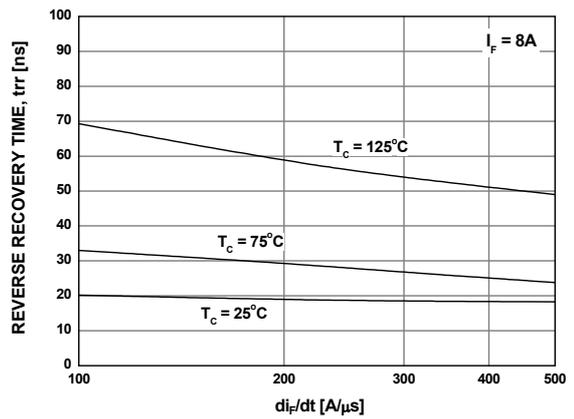
**Figure 4. Typical Reverse Current**



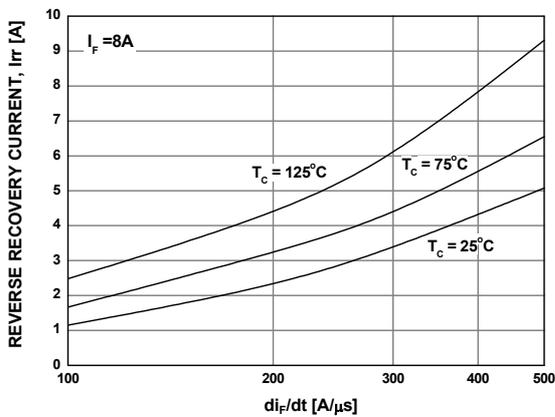
**Figure 5. Typical Junction Capacitance**



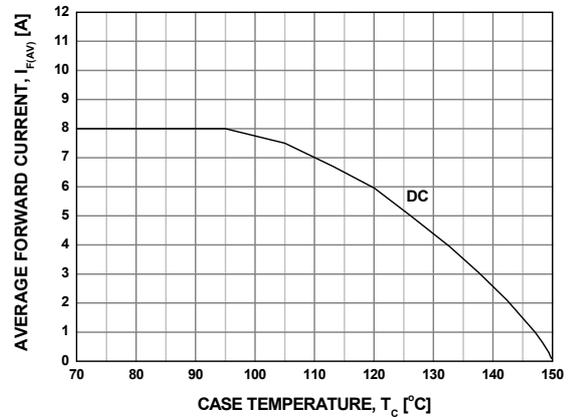
**Figure 6. Typical Reverse Recovery Time**



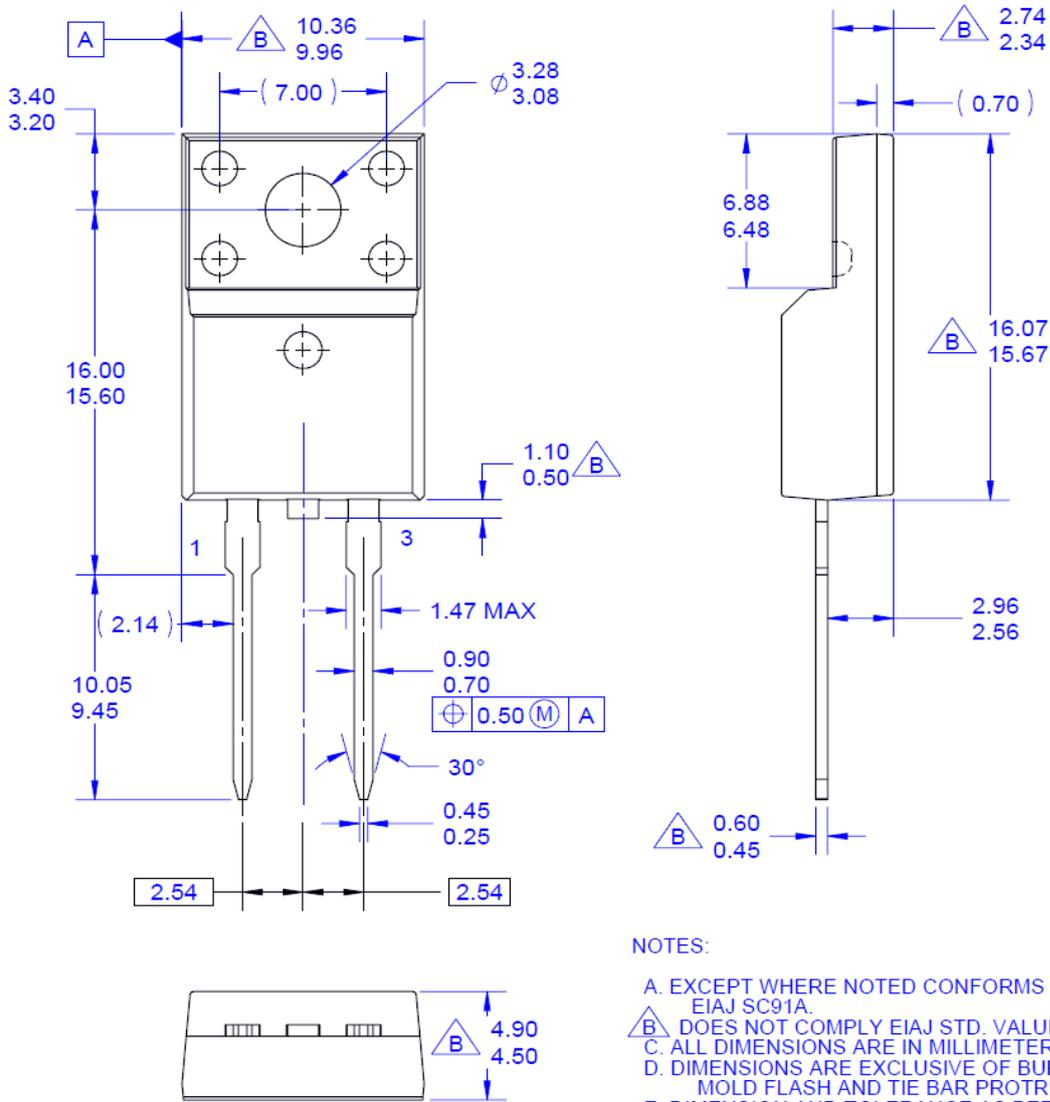
**Figure 7. Typical Reverse Recovery Current**



**Figure 8. Forward Current Deration Curve**



**Mechanical Dimensions**



**NOTES:**

- A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A.
- B. DOES NOT COMPLY EIAJ STD. VALUE.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- F. DRAWING FILE NAME: TO220C02REV2

**Figure 16. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK**

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| BitSiC™  | GreenBridge™                                    | QFET®                                 | TinyCalc™        |
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| ESBC™  | MicroPak™                                       | SuperFET®                             | Ultra FRFET™     |
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| Fairchild Semiconductor®   | MillerDrive™                                    | SuperSOT™-6                           | VCX™             |
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| FPS™   | mWSaver®  |                                       |                  |
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